



# Product Change Notification

## #112191 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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# Product Change Notification

**Change Notification #:** 112191 - 00  
**Change Title:** Intel® Thermal Solution BXRTS2011LC  
converting to Intel® Thermal Solution BXTS13X,  
PCN #112191-00, Product Material, Order Code  
**Date of Publication:** May 7, 2013

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	June 6, 2013
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## Description of Change to the Customer:

Intel will be converting from the use of Intel® Thermal Solution BXRTS2011LC to Intel® Thermal Solution BXTS13X. Intel® Thermal Solution BXTS13X will incorporate a new pump cover with a lighted Intel® logo and swirl. The Intel® Thermal Solution BXTS13X will also have an improved thermal performance.

## Customer Impact of Change and Recommended Action:

The pump cover change is a visual change only. The functional change is the improved thermal performance. There is no change to the form or fit. No impact or action is needed by customers. Customers may see a mix of products until inventory of the Intel® Thermal Solution BXRTS2011LC has been depleted.



**Products Affected / Intel Ordering Codes:**

<b>Marketing Name</b>	<b>Pre Conversion Product Code</b>	<b>Pre Conversion MM#</b>	<b>Post Conversion Product Code</b>	<b>Post Conversion MM#</b>
Intel® Thermal Solution	BXRTS2011LC	918092	BXTS13X	929672

**PCN Revision History:****Date of Revision:**

May 7, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN